izmo

August 24, 2026

The Manager Corporate Relationship Department **BSE Limited** Floor 25, Phiroze Jeejeebhoy Tower Dalal Street, Mumbai-400001	The Manager – Listing Department **National Stock Exchange of India Limited** Exchange Plaza, 5th Floor Plot No. C/1, G Block, Bandra Kurla Complex, Bandra(E), Mumbai-400051
BSE Scrip Code: **532341**	NSE Symbol: **IZMO**

Dear Sir/Madam,

Subject: Investors' Presentation

In terms of Regulation 30 of the SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015, we submit herewith a copy of Investors Presentation with respect to Business Overview and Business Update Release of Izmo Limited ("the Company").

Further a copy of the same is also available on the website of the Company, viz., ***www.izmoltd.com***

Kindly take the same on record.

Thanking You

Yours faithfully,
for **IZMO Limited**

VARUN KUMAR SRIDHARA ADGUR

Digitally signed by VARUN KUMAR SRIDHARA ADGUR
Date: 2026.08.24 17:18:31 +05'30'

Varun Kumar A S
Company Secretary and Compliance Officer

Enc: As Above

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BUSINESS UPDATE RELEASE

IZMO Q1 FY27 Revenue Up 15.7%, Operating EBITDA Up 69.6%

Semiconductor Business Sustains Higher Quarterly Revenue Level

Consolidated results for the quarter ended 30th June 2026

BENGALURU, India, August 24, 2026 - izmo Limited (NSE: IZMO | BSE: 532341) Business Update release on consolidated financial results for the quarter ended 30th June 2026 (Q1 FY27). The Company reported growth in revenue, operating profitability and net profit.

Particulars	Q1 FY27	Q1 FY26	YoY Change
Revenue from Operations	₹ 65.38 Cr	₹ 56.51 Cr	**+15.7%**
Operating EBITDA	₹ 16.39 Cr	₹ 9.67 Cr	**+69.6%**
Operating EBITDA Margin	25.1%	17.1%	**+796 bps**
Profit After Tax	₹ 12.20 Cr	₹ 6.00 Cr	**+103.1%**
PAT Margin	18.7%	10.6%	**+803 bps**
EPS (Basic)	₹ 8.15	₹ 4.03	**+102.2%**

Operating EBITDA is defined as Revenue from Operations less Raw Material/Purchase costs (net of inventory changes), Employee Benefit Expenses and Other Expenses. It excludes Other Income, Depreciation and Amortisation, Finance Costs and exceptional items. A reconciliation to reported PBT is presented in the Company's Q1 FY27 Investor Presentation. YoY percentages are as reported in the filed quarterly financial results and are calculated from the underlying figures.

Export revenue was ₹56.10 crore (85.8% of revenue from operations). Domestic revenue was ₹9.28 crore (14.2%).

Recent Quarterly Revenue by Business Division

Business division revenue is based on internal management reporting and does not represent reportable operating segments under Ind AS 108.

Division (₹ Cr)	Q2 FY26	Q3 FY26	Q4 FY26	Q1 FY27
izmocars	16.03	15.56	28.75	**16.89**
izmostudio	24.38	24.47	55.93	**24.11**
FrogData	15.89	15.35	15.25	**15.14**
izmo Microsystems	3.81	3.73	9.23	**9.24**

izmo Microsystems sustained its higher quarterly revenue level for a second consecutive quarter, with ₹9.24 crore in Q1 FY27 compared with ₹9.23 crore in Q4 FY26, approximately 2.5 times the ₹3.7–3.8 crore level recorded in Q2 and Q3 FY26. Q4 FY26 included elevated revenue contributions from izmocars and izmostudio. FrogData remained broadly stable across all four quarters.

Digital Intelligence

The Company added 170 new clients during Q1 FY27: 117 in the United States and 53 in Europe and the United Kingdom. Gross Revenue Retention Rate was 98.5%.[1]

FrogData expanded its FixedOps portfolio across the US dealer market. FrogData solutions, including FixedOps Mojo and FixedOps Velocity, were made available through the FordDirect ecosystem. izmo's digital platforms serve automotive customers across 28 countries, with over 3,000 dealers using the Company's platforms.

Gross Revenue Retention Rate is measured on a trailing-twelve-month basis as a percentage of beginning-of-period recurring revenue.

izmo Microsystems - Semiconductor Packaging

izmo Microsystems recorded revenue of ₹9.24 crore in Q1 FY27, maintaining the step-up in quarterly revenue first achieved in Q4 FY26. The higher revenue level comes as izmo Microsystems continues to expand its participation in India's defence and strategic electronics markets, supported by capabilities in System-in-Package, RF and microwave packaging, 3D die stacking, fine-pitch wire bonding and Class 1000 cleanroom facilities in Bangalore.

izmo Microsystems continues its work with the Centre for Programmable Photonic Integrated Circuits and Systems (CPPICS) at IIT Madras, where it serves as Photonic IC Packaging Partner under the MeitY-supported program. The relationship supports the Company's growing capabilities in silicon photonics, a technology area seeing increasing global interest as data center and telecom networks move toward higher-bandwidth optical interconnects. izmo Microsystems also continues to execute on semiconductor packaging programs for India's defence electronics sector, including high-frequency RF module packaging and radar receiver module assembly, and has developed a high-complexity silicon photonics module for space payloads.

The Company's established collaboration with CCRAFT SA and Alcyon Photonics covers advanced photonic integrated circuit solutions across datacom, telecom, aerospace and sensing applications, complementing izmo Microsystems' capabilities in photonic packaging and integration.

Policy Context

On 15 July 2026, the Union Cabinet approved Semicon 2.0 with an outlay of ₹1,27,500 crore. Strengthening India's ATMP/OSAT industry, with a focus on advanced packaging technologies, is one of the programme's six pillars.

Commentary

Mr. Sanjay Soni, Managing Director, izmo Limited, commented:

"Q1 FY27 reflects continued progress across the business, with revenue up 15.7% and Operating EBITDA margins expanding to 25.1%. Our digital intelligence businesses continue to provide a stable, high-retention operating base, while izmo Microsystems has now sustained a materially higher quarterly revenue level for two consecutive quarters. The technical capabilities we have built in advanced semiconductor packaging, across silicon photonics, defence electronics and space payload electronics, together with our relationships in India and Europe, give us a strong foundation as we expand the semiconductor business. We remain focused on disciplined execution across both platforms."

About izmo Limited

izmo Limited is a global technology company founded in 1995 with two growth platforms: Digital Intelligence and Semiconductor Packaging. The Company's digital intelligence businesses, comprising izmocars, izmostudio and FrogData, provide digital retail, automotive imagery, interactive content, AI-powered analytics and fixed-operations solutions to automotive customers across 22 countries. The Company's R&D unit is recognised by the Department of Scientific & Industrial Research (DSIR).

About izmo Microsystems

izmo Microsystems is izmo Limited's advanced semiconductor packaging and systems business. Capabilities include System-in-Package, RF and microwave packaging, power modules, silicon photonics assembly and 3D integration, delivered from the Company's Bangalore manufacturing facility.

Important Notice

Investor Contact

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Q1 FY27 Investor Presentation

QUARTER ENDED 30TH JUNE, 2026

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Disclaimer and Definitions

⚠ This presentation is for information purposes only and does not constitute an offer or invitation to purchase or subscribe for any securities.

This presentation has been prepared by IZMO Limited (the "Company") for information purposes only and does not constitute an offer, recommendation or invitation to purchase or subscribe for any securities. No offering of securities will be made except by means of a statutory offering document containing detailed information about the Company.

This presentation contains certain forward-looking statements relating to the Company's business, financial performance and strategy. Such statements are based on management's current expectations and are subject to risks, uncertainties and assumptions that could cause actual results to differ materially. These include, but are not limited to, the performance of the Indian and global economies, industry conditions, competition, the Company's ability to execute its strategy, technological changes, and changes in revenue, income or cash flows. The Company assumes no obligation to update any forward-looking information contained herein.

Non-Ind AS financial measure: This presentation uses Operating EBITDA, a non-Ind AS financial measure defined as Revenue from Operations less Raw Material/Purchase costs (net of inventory changes), Employee Benefit Expenses, and Other Expenses. Operating EBITDA excludes Other Income, Depreciation and Amortisation, Finance Costs and exceptional items, where applicable. This measure is not defined under Ind AS and may not be comparable to similarly titled measures used by other companies. A reconciliation to reported Profit Before Tax is presented in Slide 8.

Business-division revenue is based on internal management reporting and does not represent reportable operating segments under Ind AS 108. Business-division revenue reconciles to consolidated revenue from operations as reported in the filed quarterly financial results.

MD'S MESSAGE

A Strong Start to FY27

We have begun FY27 on a strong footing, with continued growth across the business and improved operating profitability.

Revenue from operations grew 15.7% year-on-year to ₹65.38 crore, while Operating EBITDA increased 69.6% to ₹16.39 crore, with margins expanding to 25.1%. Profit after tax more than doubled to ₹12.20 crore. During the quarter,

we added 170 new clients across the US, Europe and the UK, while Gross Revenue Retention remained strong at 98.5%. Our digital businesses continue to provide a stable operating base, while izmo Microsystems sustained the higher revenue level achieved in Q4 FY26. We are particularly encouraged by the progress at izmo Microsystems, where our capabilities in semiconductor packaging, defence electronics and silicon photonics are creating new opportunities.

We remain focused on disciplined execution across both our established digital businesses and our emerging semiconductor platform.

- Mr. Sanjay Soni

Managing Director,
izmo Limited

Q1 FY27 HIGHLIGHTS

Key Financial Metrics

Consolidated financials for the quarter ended 30th June, 2026

₹65.38Cr

Revenue from Operations

+15.7% YoY

₹16.39Cr

Operating EBITDA

+69.6% YoY

25.1%

Operating EBITDA Margin

+796 bps YoY

₹12.20Cr

Profit After Tax

+103.1% YoY

18.7%

PAT Margin

+803 bps YoY

₹8.15

EPS (Basic, ₹)

+102.2% YoY

170 New Clients Added

117 in the US and 53 in Europe/UK, demonstrating continued international demand for izmo's digital platforms.

98.5% Gross Revenue Retention

Reflects the stickiness and high satisfaction levels of IZMO's long-standing customer relationships across its SaaS and recurring revenue base.

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izmo at a glance

A Global Technology Business with Two Growth Platforms

Founded 1995

Three decades of technology and automotive experience across global markets.

28 Countries

Digital solutions deployed across major automotive markets worldwide.

3,000+ Dealers

Automotive dealers actively using izmo's digital platforms globally.

170 New Clients

New clients added during Q1 FY27 across the US, Europe and UK.

Digital Intelligence Platform

izmocars - Digital retail, marketing and customer engagement

izmostudio - Automotive imagery, content and interactive experiences

FrogData - AI-powered analytics and fixed-operations solutions

izmo Microsystems

Advanced semiconductor packaging, System-in-Package and silicon photonics for defence, space, telecom and advanced computing applications.

Global revenue base: Exports represent 85.8% of Q1 FY27 revenue and 93.2% of FY26 revenue.

KEY STRENGTHS

Established Digital Platform. Emerging Semiconductor Capability.

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Global Automotive Footprint

Multi-country, multilingual digital platforms serving automotive customers across 22 countries.

Recurring Digital Revenue Base

Long-standing customer relationships, SaaS and recurring revenue models, supported by 98.5% Gross Revenue Retention.

Proprietary Automotive Content

Extensive automotive image assets together with interactive, 3D and digital merchandising capabilities.

AI and Data Analytics

AI and analytics embedded across customer engagement, automotive retail and service operations.

Advanced Semiconductor Packaging

Capabilities spanning SiP, RF/MW packaging, 3D integration and silicon photonics.

R&D-Led Organization

DSIR-recognised R&D capabilities spanning software, AI, digital imaging and advanced semiconductor packaging.

Experienced Teams

Deep domain experience across automotive technology, digital content, analytics and semiconductor manufacturing.

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Financial Performance

Q1 FY27 Consolidated Results

Quarter ended 30th June, 2026

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FINANCIALS

Consolidated Financial Performance

Quarter ended 30th June, 2026 (₹ Crores)

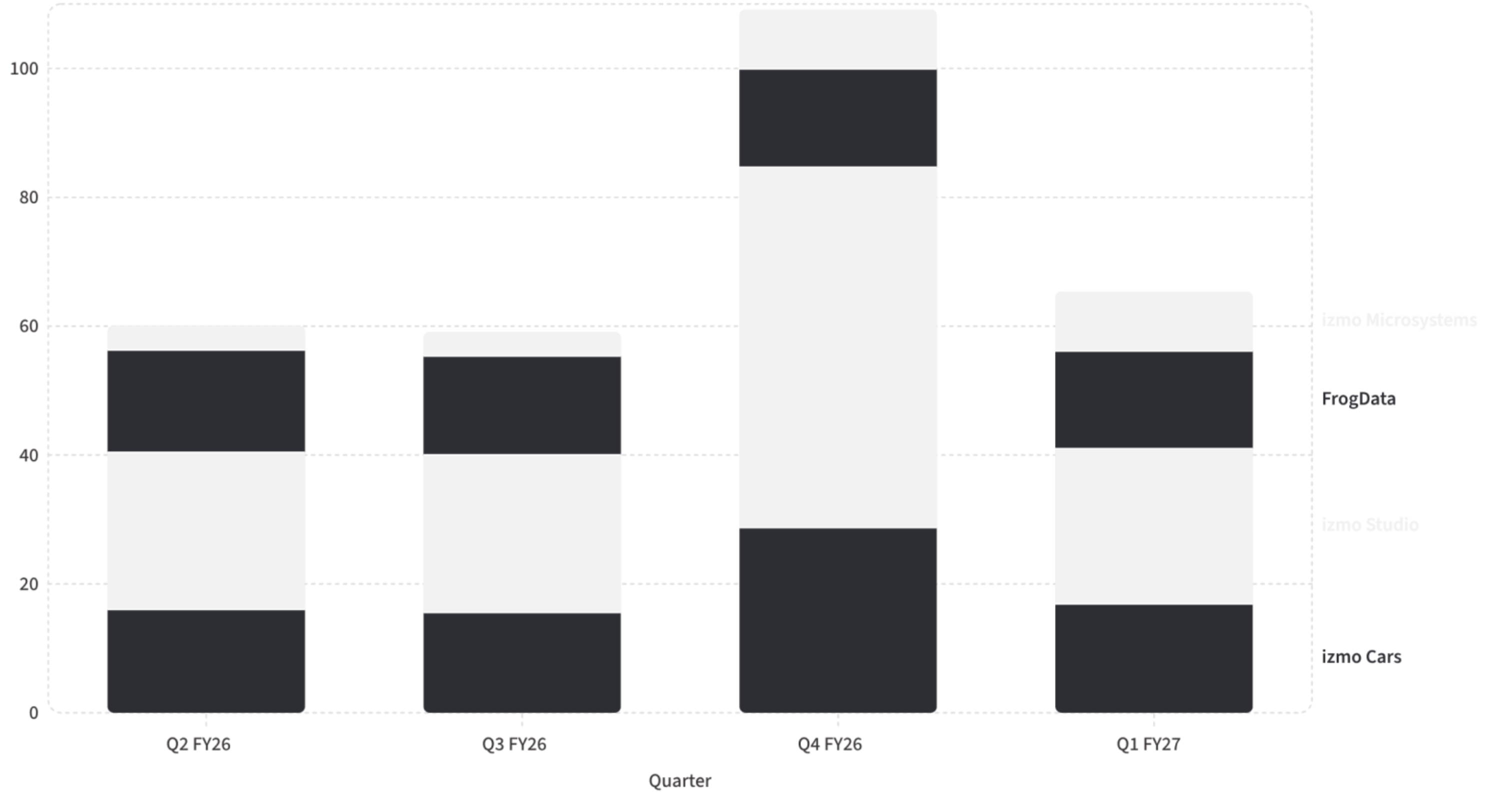
Particulars	Q1 FY27	Q1 FY26	YoY
Revenue from Operations	65.38	56.51	+15.7%
Raw Material / Purchases (net)	2.22	1.58	—
Employee Benefit Expenses	32.57	28.16	—
Other Expenses	14.20	17.10	—
Operating EBITDA	**16.39**	**9.67**	**+69.6%**
Operating EBITDA Margin	**25.1%**	**17.1%**	**+796 bps**
Other Income	0.34	0.96	—
Depreciation and Amortisation	4.06	4.20	—
Finance Costs	0.48	0.43	—
Profit Before Tax	**12.20**	**6.00**	**+103.1%**
Tax	0.00	0.00	—
Profit After Tax	**12.20**	**6.00**	**+103.1%**
PAT Margin	**18.7%**	**10.6%**	**+803 bps**
EPS (Basic, ₹)	**8.15**	**4.03**	**+102.2%**

Q4 FY26 Other Expenses of ₹69.00 Cr include costs directly associated with elevated order delivery in that quarter. Tax expense is nil for Q1 FY27 and Q1 FY26, reflecting available tax losses in overseas subsidiaries. YoY percentages compare Q1 FY27 to Q1 FY26. Q4 FY26 shown for sequential reference. Source: Filed quarterly financial results.

REVENUE TREND

Quarterly Revenue Trend and Q4 FY26 Context

Q4 FY26 included elevated revenue contribution from izmocars and izmostudio. FrogData remained broadly stable, while izmo Microsystems moved to a higher quarterly revenue level in Q4 and sustained that level in Q1 FY27.



izmo Microsystems sustained its higher revenue level for a second consecutive quarter, with Q1 FY27 revenue of ₹9.24 Cr compared with ₹9.23 Cr in Q4 FY26 — representing approximately 2.5× the levels seen in Q2/Q3 FY26.

Business-division information is based on internal management reporting and does not represent reportable operating segments under Ind AS 108.

FULL YEAR CONTEXT

FY26: Strong Improvement in Underlying Operations

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₹284.88Cr	₹52.09Cr	18.3%
Revenue from Operations	Operating EBITDA	Operating EBITDA Margin
FY25: ₹224.61 Cr	FY25: ₹38.31 Cr	FY25: 17.1%
+26.8% YoY	**+36.0% YoY**	**+123 bps YoY**

FY25 Other Income of ₹35.26 Cr included a non-recurring gain of ₹30.53 Cr from sale of property (Note 22 of the FY25 audited consolidated financial statements). FY26 Other Income was ₹14.75 Cr. This non-recurring item affects the comparability of reported PBT and PAT between FY25 and FY26. The operating metrics above, which exclude all Other Income from both years, provide a like-for-like view of underlying business performance.

REVENUE MIX

Export and Domestic Revenue Mix

Revenue Breakdown (₹ Crores)

Segment	Q1 FY27	FY26
Export Revenue	56.10 (85.8%)	265.53 (93.2%)
Domestic Revenue	9.28 (14.2%)	19.35 (6.8%)
Total	**65.38**	**284.88**

Growing Domestic Contribution

Domestic revenue in Q1 FY27 alone (₹9.28 Cr) approaches **half of FY26's full-year domestic revenue** (₹19.35 Cr). This is consistent with the growing contribution of izmo Microsystems and the Company's expanding domestic business footprint.

While exports remain the dominant revenue stream, the increasing domestic share reflects the strategic buildout of izmo Microsystems' capabilities serving India's defence, space and telecom sectors.

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Market Opportunity

Automotive Digital Retail and
Advanced Semiconductor Packaging

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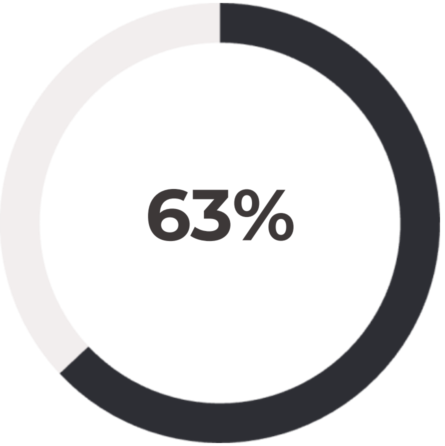
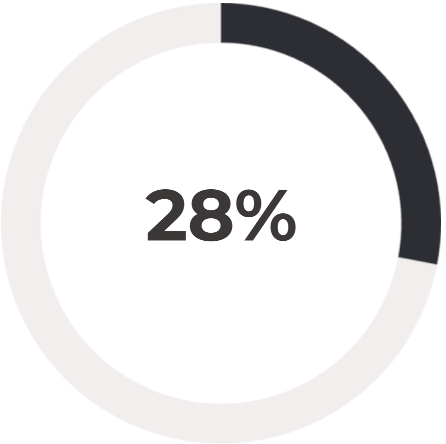
MARKET OPPORTUNITY

Automotive Digital Retail



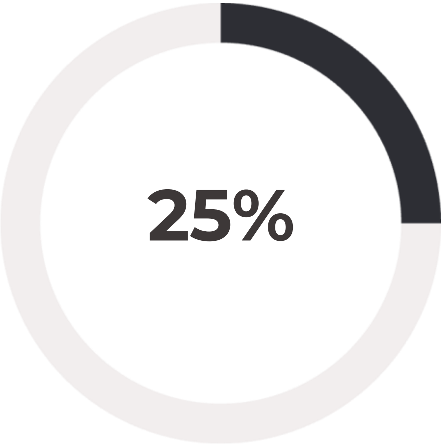
Omnichannel Preference

of car buyers prefer a seamless omnichannel buying experience



Fully Online

would prefer to complete their vehicle purchase entirely online



AI Tools Adoption

of new-vehicle buyers already use AI tools in their research process

Digital Discovery & Merchandising

Rich imagery, interactive content and virtual showrooms increasingly shape vehicle discovery online.

Connected Retail

Consumers expect a seamless journey from online research through pricing, financing and dealership interaction.

AI-Powered Journeys

AI is increasingly influencing research, personalisation, recommendations and customer engagement.

Automotive digital content creation market: US$7.1 Bn in 2024 → US$15.1 Bn by 2030.

- Sources: Cox Automotive, 2025 Car Buyer Journey Study; Grand View Research.

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MARKET OPPORTUNITY

Advanced Semiconductor Packaging

$33.5Bn

Market Size, 2025

Advanced semiconductor packaging addressable market

~11%

Projected CAGR

Expected market growth rate through 2035

AI, HPC & Chiplets

Demand for advanced packaging is being driven by AI and high-performance computing, heterogeneous integration, chiplet architectures and increasing requirements for bandwidth and power efficiency.

Silicon Photonics

Silicon photonics is emerging as an important enabling technology for high-speed optical connectivity in data centres and telecommunications, particularly as networks progress toward 800G and 1.6T.

Specialised Packaging Demand

These trends expand requirements for photonic IC assembly, System-in-Package, 2.5D/3D integration and high-density interconnect technologies.

Source: Global Market Insights, Advanced Semiconductor Packaging Market, February 2026; Grand View Research, Silicon Photonics Market.

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Business & Capabilities

• Digital Intelligence • izmo Microsystems • R&D

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Key Business Developments

Semiconductor Packaging

- Recognised as **Photonic IC Packaging Partner to CPPICS at IIT Madras**, under the MeitY-supported programme.
- Expanded ongoing semiconductor packaging work for India's **defence electronics sector**, including high-frequency RF module packaging and radar receiver module assembly.
- Developed a high-complexity **3D System-in-Package module for space payload camera electronics**, reducing the electronics footprint from approximately 200 × 200 mm to 81 × 81 mm.
- Strategic collaboration with **CCRAFT SA and Alcyon Photonics** for advanced photonic integrated circuit solutions across datacom, telecom, aerospace and sensing applications.

Digital Businesses

- Added **170 new clients** during Q1 FY27: 117 in the US and 53 in Europe/UK.
- FrogData **expanded its FixedOps portfolio** across the US dealer market.
- FrogData solutions made available through the **FordDirect ecosystem,** including FixedOps Mojo and FixedOps Velocity.

IZMO MICROSYSTEMS

Building Scale in Advanced Packaging

Investment in Advanced Packaging is Beginning to Translate into Growth

₹9.24Cr

Q1 FY27 Revenue

Sustained at the higher level achieved in Q4 FY26

₹9.23Cr

Q4 FY26 Revenue

The quarter that marked the step-change in revenue trajectory

~2.5×

vs Q2/Q3 FY26 Levels

Revenue approximately 2.5× the levels seen earlier in the year

Expanding Capabilities

- System-in-Package
- RF & Microwave Packaging
- Power Modules
- Silicon Photonics
- Space Electronics

Broadening End Markets

- Defence
- Telecom
- Automotive
- Space
- Advanced Computing

Technology-Led Growth

Recent development work in silicon photonics, high-density packaging and space-grade modules expands the range of addressable applications.

Global Customer Development

India-based engineering and manufacturing capabilities supported by commercial and technical teams in the US and Europe.

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IZMO MICROSYSTEMS

Advanced Semiconductor Packaging Capabilities

Investment in Advanced Packaging is Beginning to Translate into Growth

Core Capabilities

- System-in-Package (SiP)
- 3D die stacking
- Fine-pitch wire bonding
- RF and microwave packaging
- Power module packaging
- Photonic IC and silicon photonics assembly
- Hermetic and specialised packaging
- Class 1000 cleanroom capability

Key Application Areas

• Defence • Space • Telecom • Automotive
• Photonics • High-Performance Electronics

Technology Ecosystem

Photonic IC Packaging Partner to **CPPICS at IIT Madras,** supporting development in programmable photonics and related advanced photonic technologies.

Key Differentiator

Integration of design, packaging development, prototyping and manufacturing capabilities **within India** - providing a domestic alternative to international packaging specialists.

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R&D as a Common Technology Engine

Silicon Photonics

Advanced photonic IC packaging capability developed in conjunction with CPPICS at IIT Madras, enabling next-generation optical connectivity solutions.

Artificial Intelligence

izmo.ai provides AI capabilities integrated across automotive digital platforms, analytics and customer-engagement tools.

Data Engineering

DEEP (Data Extraction & Enrichment Platform) supports high-speed extraction, structuring and enrichment of large automotive datasets.

Interactive Automotive Content

Proprietary WebGL-based 3D technology enables interactive vehicle visualisation and personalisation at scale.

Semiconductor Packaging R&D

Development capabilities spanning SiP, RF/microwave modules, space-grade packaging and advanced photonics.

DSIR Recognition

IZMO's R&D unit is recognised by the Department of Scientific & Industrial Research, validating the depth and quality of its innovation capabilities.

GLOBAL PRESENCE

Global Customer Base. International Delivery. India Technology Centre.

izmo

North America

San Francisco • Chicago • Long Beach

Europe

London • Paris • Brussels

India

Bangalore - Technology, Engineering & Manufacturing Centre

28
Countries Served
through IZMO's digital platforms

85.8%
Export Revenue Share
of Q1 FY27 revenue from exports

93.2%
FY26 Export Share
of FY26 revenue from exports

India's contribution is increasing, driven in part by the growth of izmo Microsystems and its expanding domestic customer base in defence, space and telecom sectors.

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Trusted Across the Global Automotive Ecosystem.

Representative customer relationships spanning OEMs, rental and mobility operators, technology partners and semiconductor clients.

OEM & Automotive

• Ford • Stellantis • Renault • Honda • Toyota • Audi
• Nissan • Porsche • Suzuki • Fiat

Rental, Mobility & Leasing

• Hertz • Avis • Europcar • Arval (BNP Paribas)
• LeasePlan • Terberg Leasing

Technology & Digital

• Microsoft

Semiconductor Packaging

• BEL • ADS Germany • IIT Madras • SCL

Representative customers and commercial relationships across izmo businesses. Logos are trademarks of their respective owners.

STRATEGY

Strategic Priorities

Grow the Core Digital Businesses

Continue expanding izmo Cars, izmo Studio and FrogData across existing markets through new client acquisition, deeper customer relationships and additional product adoption.

Expand Automotive Digital Retail

Build on the shift toward digital and omnichannel automotive retail through richer vehicle content, interactive experiences, data-driven engagement and AI-enabled platforms.

Scale FrogData's FixedOps Platform

Expand FixedOps Mojo and FixedOps Velocity across the US automotive service market and deepen AI and analytics integration into service operations.

Develop AI Capabilities

Continue applying izmo.ai and data-engineering capabilities across automotive retail, customer engagement, analytics and internal product development.

Scale izmo Microsystems

Expand advanced semiconductor packaging capabilities across defence, telecom, space and silicon photonics while developing new customer and technology partnerships.

Invest with Capital Discipline

Evaluate funding and capacity-expansion opportunities at izmo Microsystems in line with customer demand, technology readiness and shareholder returns.

Policy context: On 15 July 2026, the Union Cabinet approved **Semicon 2.0** with an outlay of ₹1,27,500 Cr. Strengthening India's ATMP/OSAT industry, with a focus on advanced packaging technologies, is one of the programme's six pillars — a strong tailwind for izmo Microsystems.

Thank You!

izmo Limited

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